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PATENT APPLICATION

RESPONSE UNDER 37 CFR §1.116
EXPEDITED PROCEDURE
TECHNOLOGY CENTER ART UNIT 2825

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Akira SATO

Group Art Unit: 2825

Application No.: 09/424,500

Examiner: G. LEE

Filed: February 22, 2000

Docket No.: 104788

For: METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE, MOLDING
DEVICE FOR SEMICONDUCTOR DEVICE, AND SEMICONDUCTOR DEVICE

REQUEST FOR RECONSIDERATION
AFTER FINAL REJECTION UNDER 37 CFR §1.116

Director of the U.S. Patent and Trademark Office
Washington, D.C. 20231

Sir:

In reply to the Office Action mailed November 19, 2002, reconsideration of the
above-identified application is respectfully requested

Claims 1-9, 11-18, 20-22, 24-27, 29 and 30 are pending.

Applicant appreciates the Office Action's indication that claims 11 and 24 contain
allowable subject matter.

The Office Action rejects claims 1-7, 15-17, 20 and 21 under 35 U.S.C. §102(b) over
JP 09076282, claims 25 and 26 under 35 U.S.C. §103(a) over JP '282 and claims 8, 9, 12, 14,
18, 22, 27 and 30 under 35 U.S.C. §103(a) over JP '282 in view of JP 06177268. These
rejections are respectfully traversed.

JP '282 does not disclose applying a pressure to the semiconductor assembly by at
least one support pin so as to cause a stress in the lead frame as recited in independent claim

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1, applying a pressure to the heat radiator by at least one support pin so as to cause a stress in the lead frame as recited in independent claim 12 and applying a pressure to the semiconductor assembly with the support pin so as to cause a stress in the lead frame as in the invention of claim 15.

Instead, JP '282 discloses a substrate 2 that is sandwiched between pins 10 and 11. Thus, no stress is caused in the substrate 2.

In view of the foregoing, Applicant respectfully submits that this application is in condition for allowance. Favorable consideration and prompt allowance are earnestly solicited.

Should the Examiner believe that anything further would be desirable in order to place the application in even better condition for allowance, the Examiner is invited to contact Applicant's undersigned representative at the telephone number listed below.

Respectfully submitted,



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JAO:MB/jfl

Date: February 19, 2003

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